

S4D20120A 1200V SIC POWER SCHOTTKY RECTIFIERS



Description

This 1200V 20A diode is high voltage Schottky rectifier that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S4D20120A is ideal for energy sensitive, high frequency applications in challenging environments.

Circuit Diagram



Features

- 175°C TJ operation
- Ultra-low switching loss
- Switching speeds independent of operating temperature
- Low total conduction losses
- High forward surge current capability
- High package isolation voltage
- Terminals finish: 100% Pure Tin
- "-A" is an AEC-Q101 qualified device
- Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request

Applications

- Alternative energy inverters
- Power Factor Correction (PFC)
- Free-Wheeling diodes
- Switching supply output rectification
- Reverse polarity protection

Maximum Ratings

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage	V_{RRM}	-	1200	V
Working Peak Reverse Voltage	V_{RWM}	-	1200	V
DC Blocking Voltage	V_R	-	1200	V
Average Rectified Forward Current	$I_{F(AV)1}$	@Tc=25°C	59	A
	$I_{F(AV)2}$	@Tc=152°C	20	A
Repetitive Peak Forward Surge Current	I_{FRM1}	10 ms, Half Sine pulse, Tc =25°C	140	A
	I_{FRM2}	10 ms, Half Sine pulse, Tc =110°C	110	A
Peak One Cycle Non-Repetitive Surge Current	I_{FSM1}	10ms, Half Sine pulse, Tc =25°C	240	A
	I_{FSM2}	10ms, Half Sine pulse, Tc =110°C	195	A
Non-Repetitive Peak Forward Surge Current	$I_{F,Max1}$	10µs. Pulse, Tc =25°C	1150	A
	$I_{F,Max2}$	10µs. Pulse, Tc =110°C	950	A
Power Dissipation	P_{tot1}	Tc=25°C	263	W
	P_{tot2}	Tc=110°C	114	W

Electrical Characteristics:

Characteristics	Symbol	Condition	Typ.	Max.	Units
Forward Voltage Drop*	V_{F1}	@ 20A, Pulse, T _J = 25°C	1.5	1.8	V
	V_{F2}	@ 20A, Pulse, T _J = 175°C	2.2	3.0	V
Reverse Current*	I_{R1}	@V _R = rated V _R T _J = 25°C	1	25	µA
	I_{R2}	@V _R = rated V _R T _J = 175°C	10	150	µA
Junction Capacitance	C_T	VR=0V, T _J =25°C, f=1MHz	1620	-	pF
Reverse Recovery Charge	Q_C	I _F = 20A, di/dt = 200A/µs VR = 800 V, T _J =25°C	124.89	-	nC
Capacitance Stored Energy	E_C	V _R = 800 V, T _J =25°C	64.20	-	µJ

* Pulse width < 300 µs, duty cycle < 2%

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	T _J	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R _{θJC}	DC operation	0.57	°C/W

Ratings and Characteristics Curves

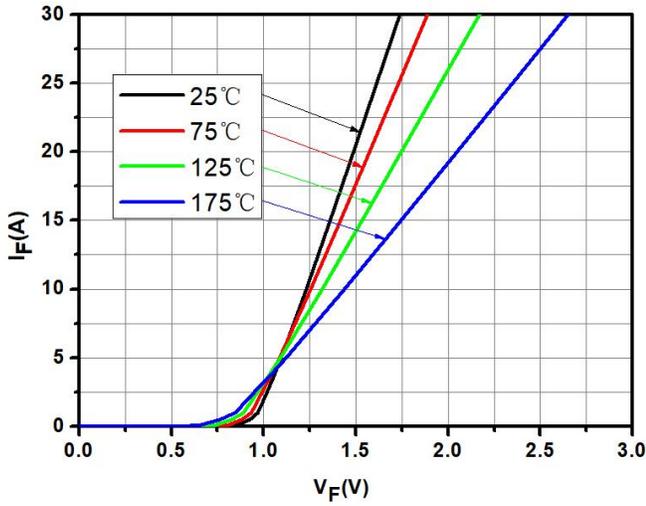


Fig.1-Typical Forward Voltage Characteristics

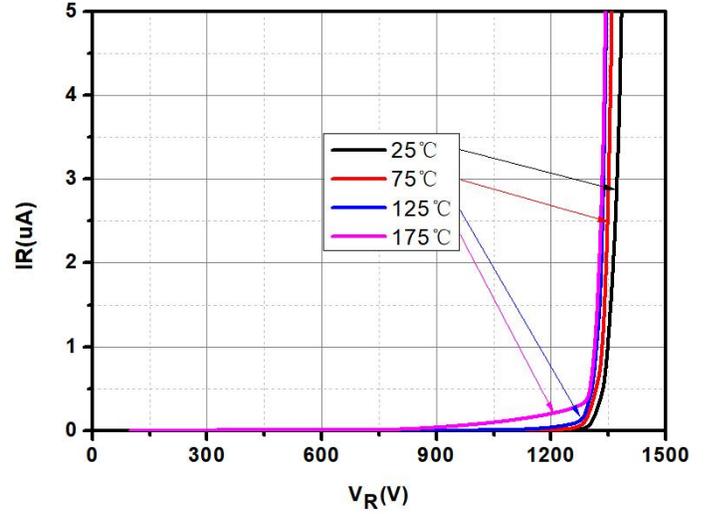


Fig.2-Typical Reverse Characteristics

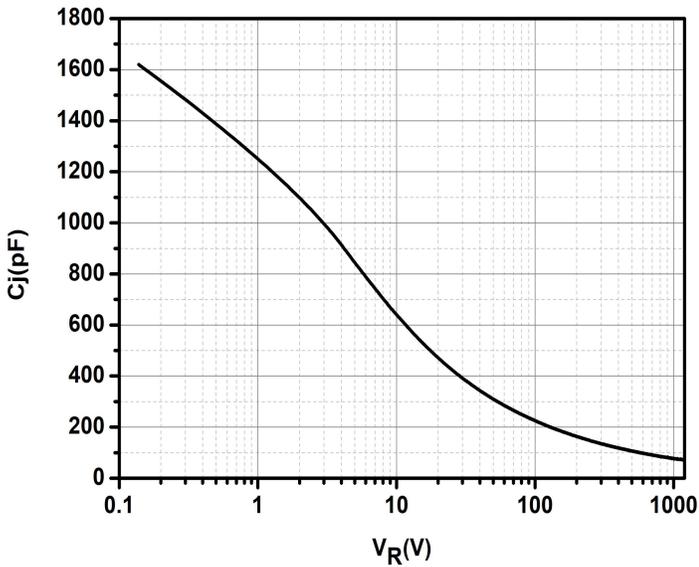


Fig.3-Capacitance vs. Reverse Voltage

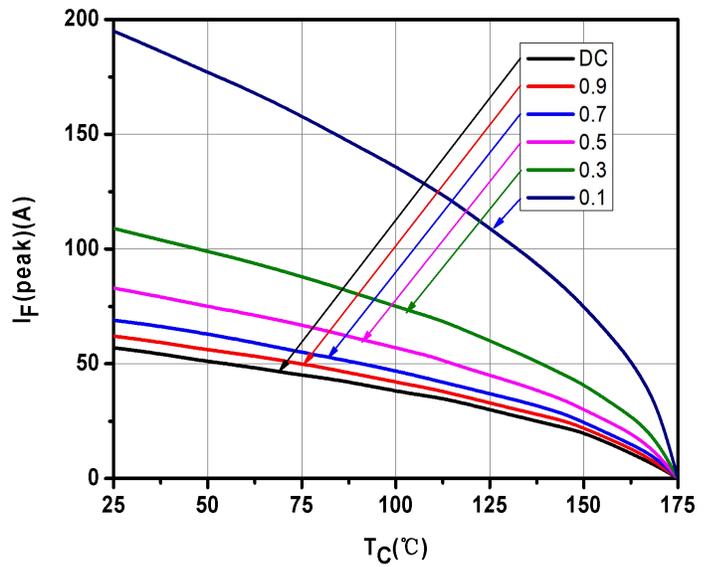


Fig.4-Current Derating

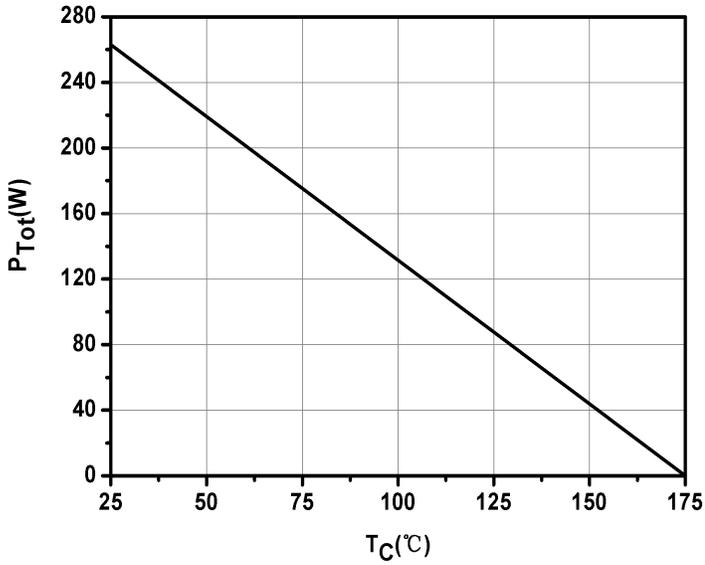


Fig.5-Power Derating

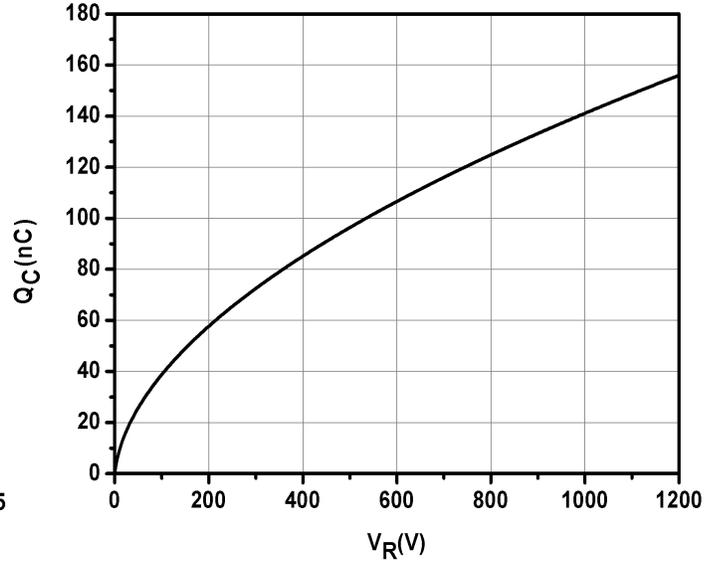


Fig.6-Total Capacitance Charge vs. Reverse Voltage

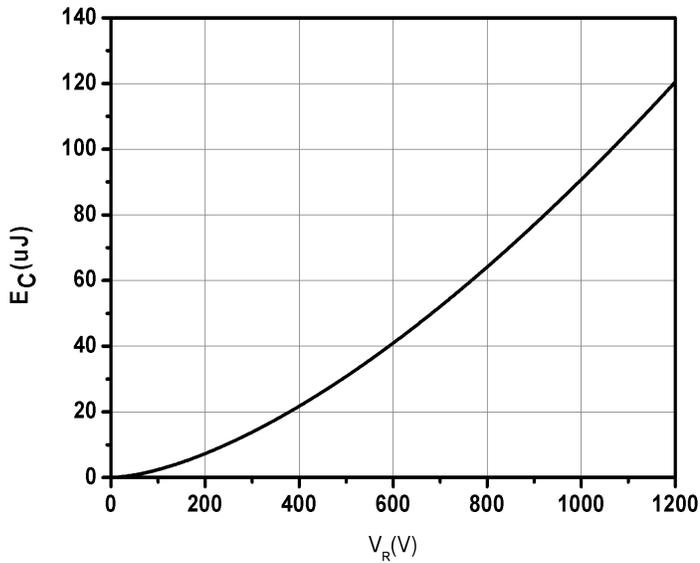
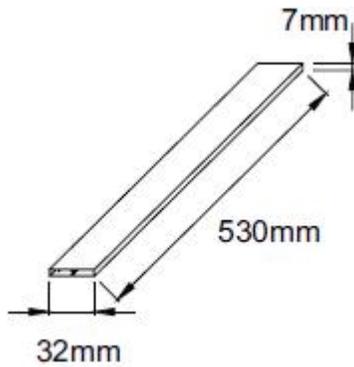


Fig.7-Capacitance Stored Energy

Ordering Information

Device	Package	Shipping
S4D20120A	TO-220AC(TO-220-2)	50pcs / tube

Tube Specification



Marking Diagram

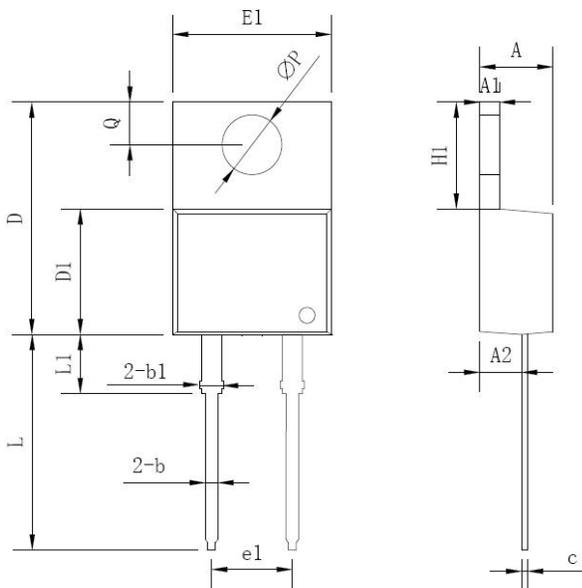


Where XXXXX is YYWWL

S4D = Device Type
A = Package type
20 = Forward Current (20A)
120 = Reverse Voltage (1200V)
SSG = SSG
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL : 94V-0

Mechanical Dimensions



Symbol	Dimensions in millimeters		
	Min.	Typical	Max.
A	3.56	-	4.83
A1	0.51	-	1.40
A2	2.03	-	2.92
b	0.38	-	1.02
b1	1.14	-	1.78
c	0.31	-	0.61
D	14.22	-	16.51
D1	8.38	-	9.42
E1	9.65	10.16	10.67
e1	-	5.08	-
H1	5.84	-	6.86
L	12.70	-	14.73
L1	-	-	6.35
ΦP	-	3.56	-
Q	2.54	-	3.43

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